Control Challenges for Low Power AC/DC Converters

Brian King and Rich Valley



Content Outline

1. The Low Power Flyback Converter

- Characteristics
- Key performance
- Typical operating and control modes

2. PSR Regulation Methods

- Constant Voltage (CV) regulating V_{OUT}
- Constant Current (CC) regulating I_{OUT}

3. Low Standby Power

- Lowering consumption
- Achieving low input power

4. Results and Comparison (10 W at 5 V)

- DCM and variable frequency primary side voltage and current control
- DCM and fixed frequency optical coupler feedback
- DCM, variable frequency optical coupler feedback, primary side current control

The Low Power AC/DC Flyback

Key Points

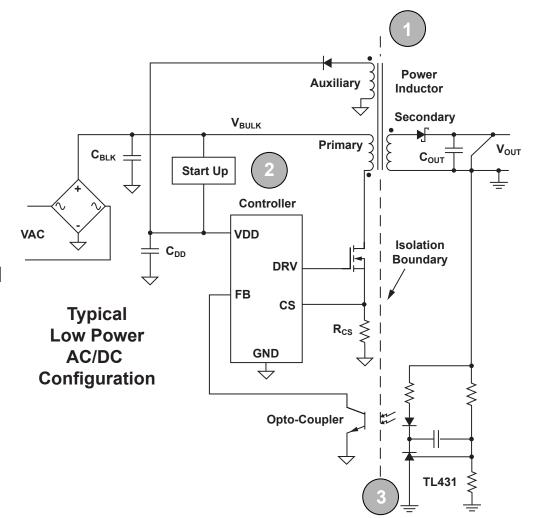
- 1. Power inductor
 - AKA, flyback transformer
 - 3rd "bootstrap" winding

2. PWM Control

- Peak current control
- Switching frequency control
- Low pin count
- Requires start-up circuit

3. Feedback

- TL431 network
- Optical Coupler



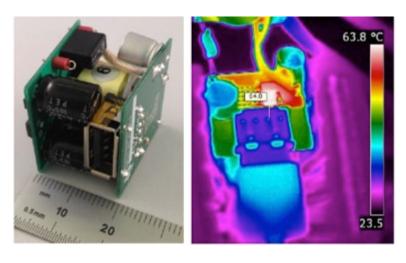
The Low Power AC/DC Power Supplies

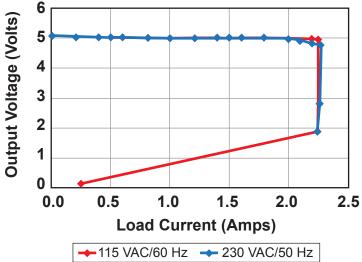
3-35 Watts, 3 V to 20 V

- Universal input, 85-265 VRMS
- AC/DC adapters and chargers
- Set top boxes
- E-meters
- Auxiliary supplies DTV, servers...

Key Parameters

- Size and cost
- Voltage and current control
- Efficiency
- Standby power

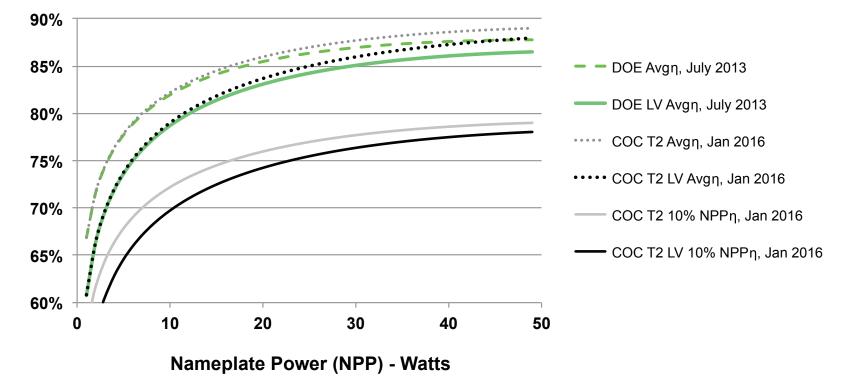




Performance – Efficiency

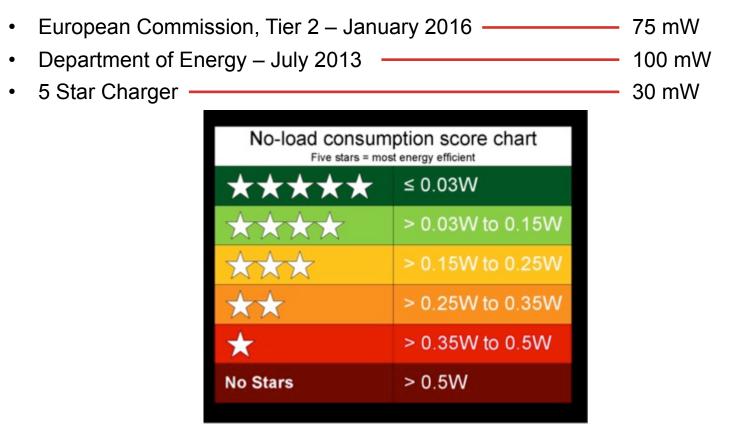
Efficiency standards for External Power Supplies (EPS)

- Department of Energy, DOE
- European Commission Code of Conduct, COC



Performance – Standby Power

Efficiency standards for External Power Supplies (EPS)



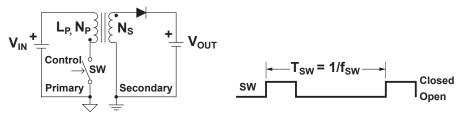
• OEM specifications at 10 mW and asking for 5 mW

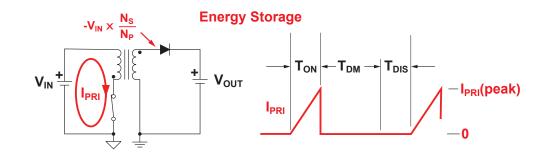
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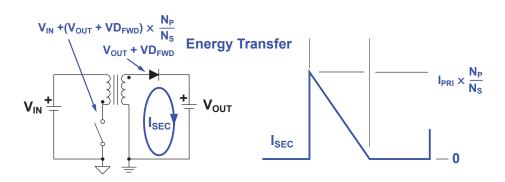
Discontinuous Current Mode (DCM)

- Single switch control
- T_{ON}:
 - Switch on-time
 - Energy taken from V_{IN} and stored in primary
 - Core is "magnetized"
- T_{DM}:
 - Switch is off
 - Stored energy is fully transferred to V_{OUT}
 - Core is "demagnetized"
- T_{DIS}:
 - Discontinuous time
 - Currents are zero
 - − $T_{DIS} = 0 \rightarrow$ transition mode

Basic Flyback Toplogy







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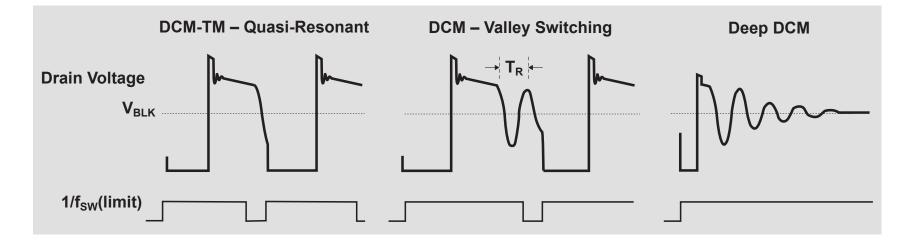
Power Control with the DCM Flyback

- Each switching cycle
 - A controlled energy is taken from the input
 - This energy (minus some losses) is delivered to the load
 - The system is at the same condition at the beginning of every cycle

1)
$$CE_{ST} = \frac{1}{2} L_P \times I_{PRI} (peak)^2$$
 (transformer energy stored each cycle)
2) $P_{IN} \cong fsw \times CE_{ST}$ (converter input power)
3) $\eta = \frac{P_{OUT}}{P_{IN}}$ (overall converter efficiency)

- Power is modulated by changing:
 - Cycles/second frequency modulation
 - Energy/cycle amplitude modulation

DCM or TM(Transition Mode) with Valley Switching

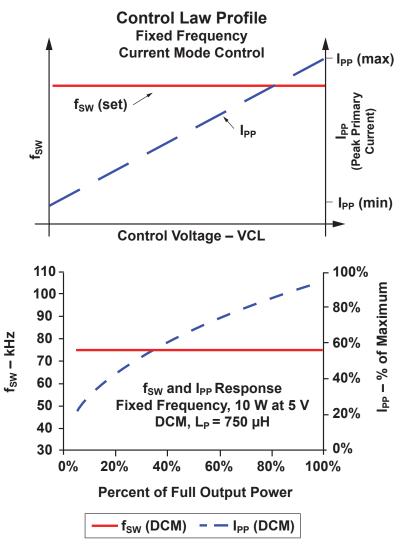


- Waiting for a zero crossing prevents continuous conduction mode (CCM)
- Switching on a valley reduces dissipation and EMI
- 1/f_{SW}(limit) sets a minimum period

DCM, Fixed Frequency Control

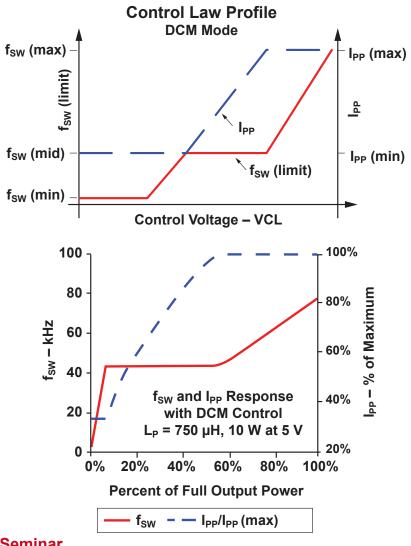
- Frequency is constant
- Peak current is modulated

- + Controlled switching frequency
- Lower efficiency
- High stand-by power
- Limited dynamic range



DCM, Variable Frequency Control

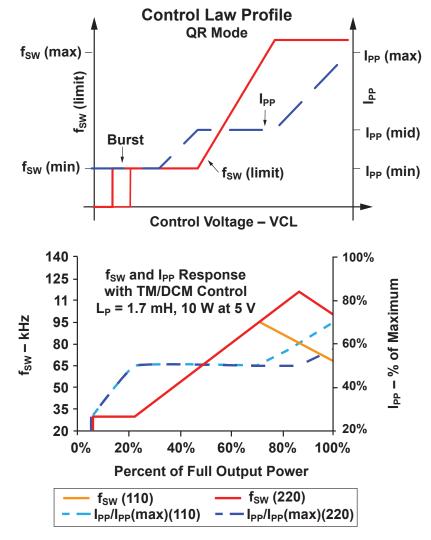
- Peak current is modulated
- Frequency is modulated
- Approaches TM at low line full load
- + Smallest inductance
- + Good efficiency
- + Best current control
- Wide frequency range



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TM/DCM, Variable Frequency Control

- Peak current is modulated
- Frequency is modulated
- Operates TM at full load
- + Better full load efficiency
- Larger primary inductance
- Wide frequency range
- Reduced input voltage rejection

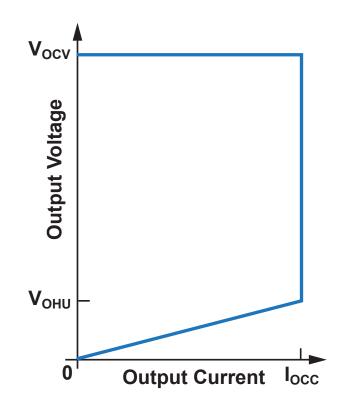


Primary Side Regulation (PSR)

Constant Voltage (CV) and Constant Current (CC) Methods

Primary Side Regulation (PSR)

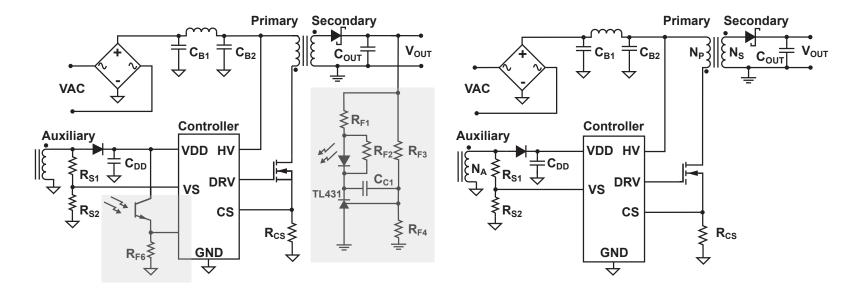
- Controlling output voltage and current with no direct sensing
- Constant Voltage (CV) for $I_0 = 0$ A to I_{OCC}
- Constant Current (CC) for $V_{O} = V_{OHU}$ to V_{OCV}
- The output hold up voltage, V_{OHU}, depends on the primary controller supply dropout



PSR – Component Reduction

From This

To This



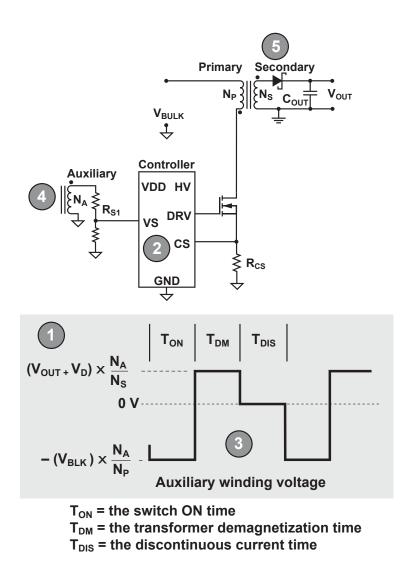
- Opto-coupler and TL431 circuits are eliminated
- Less parts = lower cost, smaller supply, higher reliability
- Less design, also less design flexibility

PSR – Feedback Concept

- 1. $V_{OUT} + V_{D,}$ scaled by a turns ratio, at Aux during T_{DM}
- 2. Use for voltage feedback (at VS input)

But....

- 3. Signal is not continuous
- 4. N_A / N_S must be controlled
- 5. V_D (output diode voltage) is a source of error
- 6. Nothing is this simple



PSR – Feedback Concept

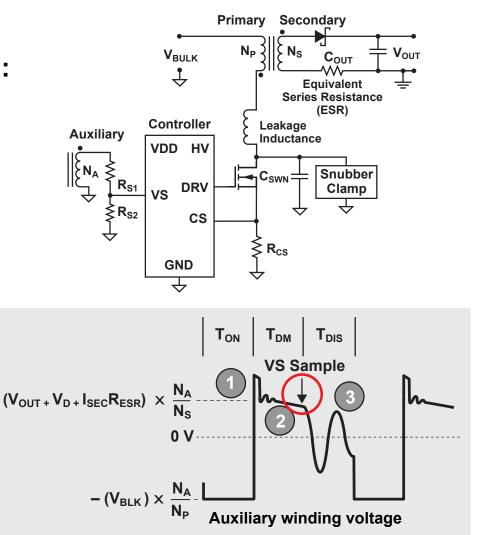
Auxiliary winding waveform:

Leakage inductance

- Reset spike
- Rings with $C_{\mbox{\scriptsize SWN}}$
- 1. ESR
 - $I_{SEC} \times R_{ESR}$ slope
- 2. C_{SWN} rings with L_P

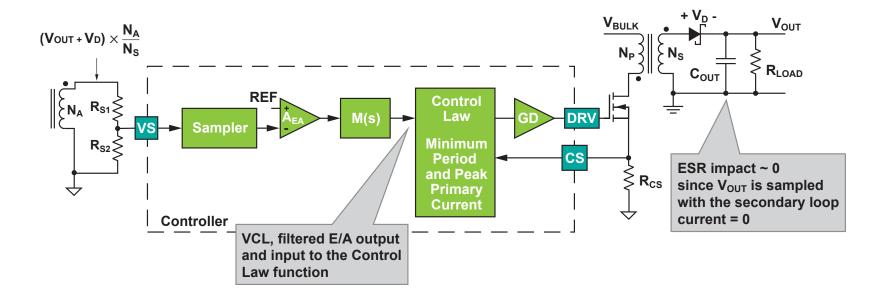
Best regulation if sampled when ${\rm I}_{\rm SEC}$ goes to zero

→ "VS sample"



PSR – Voltage Loop

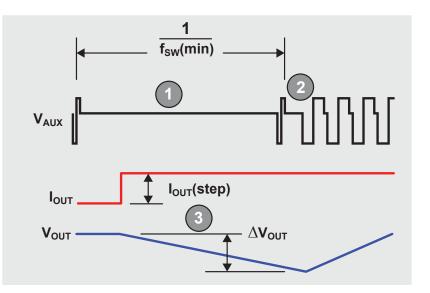
- Samples output at f_{SW} rate
- f_{SW} has wide range, >100:1, for low stand-by power
- Compensation (M(s)) done internally



PSR – Transient Response Problem

Poor Transient Response from Zero Load

- 1. Low switching frequencies
- 2. Feedback is only available during a switching event
- 3. Poor transient performance, or a very large output capacitor

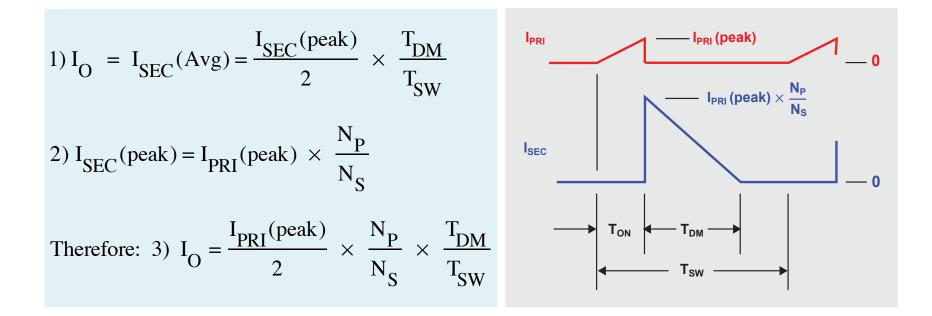


$$\Delta V_{OUT} = \frac{I_{OUT}(\text{step})}{C_{OUT} \times f_{SW}(\text{min})}$$

PSR Voltage Error Sources

- Reference, Error Amplifier, Resistors
- Rectifier Diode Drop
 - Actually regulating V_{OUT} + V_{D}
 - Diode-to-diode V_D at a fixed low current is consistent for a given diode selection
 - Diode temperature variation will impact V_{OUT} if not compensated for
- Transformer
 - Reasonable manufacturing gives good turn control
 - Impact of leakage inductance is small
- Winding Voltage Sampling Errors (generally seen at light loads)
 - Auxiliary diode, snubber diode, snubber noise corrupting signal
 - Auxiliary to secondary cross-regulation at light loads
 - VS filtering
- Generally +/- 5% is readily achievable across line and load

Constant Current Control – Concept



 Controlling the peak primary current and the demagnetization duty-cycle (T_{DM} / T_{SW}) will regulate the output current accurately (~+/-5% achievable)

Standby Power (P_{SB})

Power consumed with zero external load, a very common state for power supplies

P_{SB} Components

$$P_{SB} = f_{SW}(sb) \times CE_{IN}(min) + P_{STRT} + P_{LKG}$$

Where:

 $f_{sw}(sb) =$ converter switching frequency during stand-by

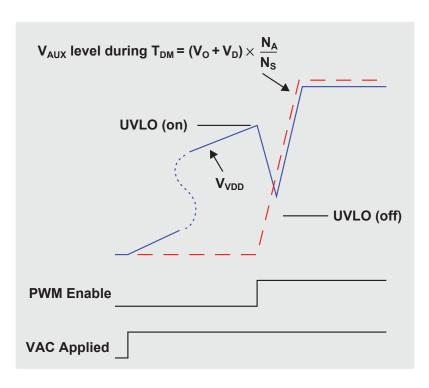
 $CE_{IN}(min) = converter minimum input cycle energy$

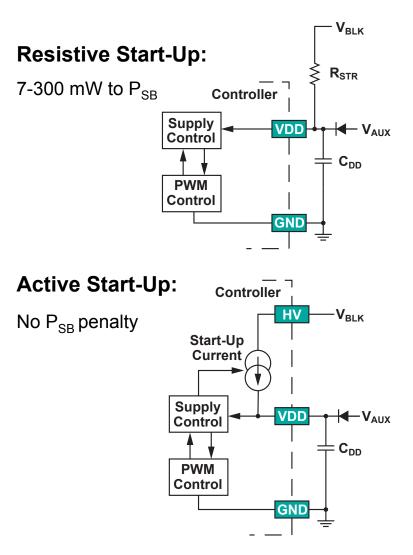
 $P_{STRT} = Start-up power$

 $P_{LKG} = \sum Capacitor and junction leakage losses$

- Generally $f_{SW} \times CE_{IN}$ dominates
 - Encompasses output preload and primary bias power
- P_{STRT} can be significant at low target P_{SB}

P_{SB} – Start-Up





P_{SB} Control Law Must Haves



- Low input energy / cycle
- Low switching frequency
- Constant time / cycle
 - Burst mode versus constant $f_{SW}(sb)$
 - Same average cycles / second worse transient response

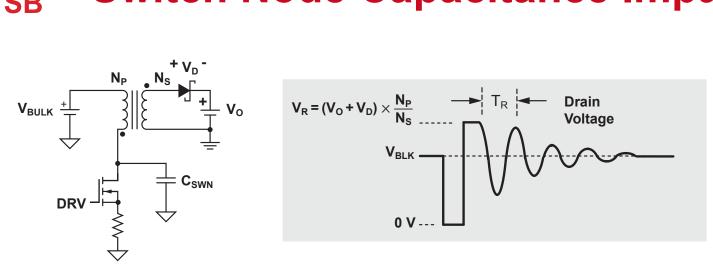
P_{SB} and **CE**_{IN}(min)

- The minimum cycle energy is dependent on the AM range and $f_{\mbox{SW}}(\mbox{max})$

$$CE_{IN}(\min) = \frac{P_{O}(\max)}{\eta_{T} \times f_{SW}(@P\max)} \left(\frac{1}{K_{AM}}\right)^{2} \quad \text{where: } K_{AM} = \frac{I_{PRI}(\text{peak},@P\max)}{I_{PRI}(\text{peak},\min)}$$

- The maximum AM range, K_{AM} , will typically be limited to 3-5
- This expression does not take into account the impact of the switch-node capacitance
- η_T is an efficiency estimate ignoring capacitive and bias loss

P_{SB} – Switch Node Capacitance Impact



• Delta input cycle energy

 $\Delta CE_{IN}(cap, total) = C_{SWN} \times V_{BLK}^{2}$

A portion of this is dissipated in the switch and tank,

 $\Delta CE_{IN}(cap, dissipated) = \frac{1}{2} \times C_{SWN} \times \left(V_{BLK}^{2} + V_{R}^{2}\right)$

• A portion goes into the transformer \rightarrow output,

$$\Delta CE_{IN}(cap, out) = \frac{1}{2} \times C_{SWN} \times \left(V_{BLK}^2 - V_R^2\right)$$

P_{SB} – Switch Node Capacitance Impact

For the example to the right ignoring the effect of $\mathrm{C}_{\mathrm{SWN}}$:

 $CE_{IN}(min) = 7.81 \ \mu J$

$$CE_{OUT}(min) = \eta_T \times CE_{IN}(min) = 6.25 \ \mu J$$

Incremental energy due to C_{SWN} : $\Delta CE_{IN}(cap, total) = 9.33 \ \mu J$

 ΔCE_{IN} (cap, dissipated) = 4.89 µJ

 $\Delta CE_{IN}(cap, out) = 4.44 \ \mu J$

$$\Delta CE_{OUT}(cap, out) \cong \eta_T \times \Delta CE_{IN}(cap, out) = 3.55 \ \mu J$$

Total minimum energy w/ C_{SWN}:

$$CE_{IN}(min, total) = 7.81 \ \mu J + 9.33 \ \mu J = 17.14 \ \mu J$$

$$CE_{OUT}(min, total) = 6.25 \ \mu J + 3.55 \ \mu J = 9.80 \ \mu J$$

Example Power Supply Parameters

P _o (max)	10 W
f _{SW} (max)	100 kHz
V _{BLK} (max)	365 V
V _R (nom)	80 V
K _{AM}	4
C _{SWN}	70 pF
η_{T}^{*}	80%

* Efficiency estimate ignoring capacitive and bias loss

Limits very light load efficiency and dictates a minimum load

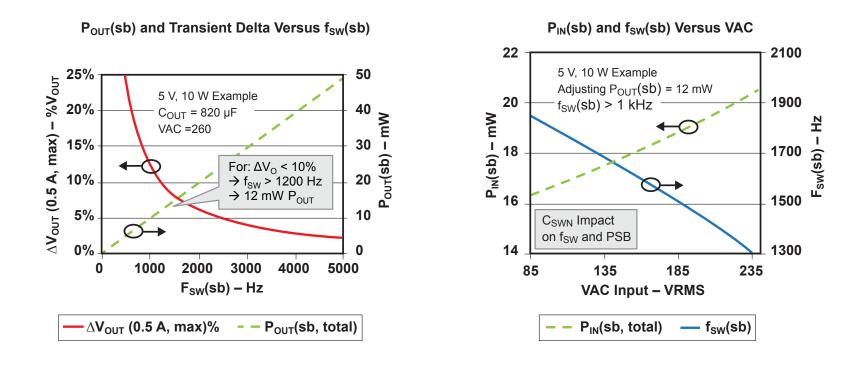
P_{SB} – Minimum Load Requirements

 The converter has a minimum load it will deliver that is equal to:

$$P_{O}(\text{sb, total}) > f_{SW}(\text{min}) \times \left(\frac{P_{O}(@P \text{max})}{f_{SW}(@P \text{max})} \left(\frac{1}{K_{AM}}\right)^{2} + \frac{\eta_{T} \times C_{SWN} \times (V_{BLK}^{2} - V_{R})^{2}}{2}\right)$$

- Bias power plus a preload will adjust f_{SW}(sb) to approach f_{SW}(min), or exceed for improved transient response
- If the preload is not adequate then regulation will be lost with $V_{\rm O}$ rising

P_{SB} – Versus Transient Response



$$P_{IN}(sb, total) > f_{SW}(sb) \times \left(\frac{P_{O}(max)}{\eta_{T} \times f_{SW}(@Pmax)} \left(\frac{1}{K_{AM}}\right)^{2} + C_{SWN} \times 2 VAC_{RMS}^{2}\right)$$

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Low Power Flyback Control Recap

- Discontinuous operation with variable frequency optimizes efficiency across load
- Primary side regulation can provide good V and I regulation but transient response can suffer
- Standby power benefits from:
 - Low switching frequencies
 - Low bias and start-up overhead
 - Low switch-node capacitance

Results and Comparison

How do different controllers affect the performance of a typical power supply?

AC/DC 5 V / 10 W Adaptor

General Specifications:

- Universal AC input: 85 V to 265 V, 50/60 Hz
- 5 V output; 2 A max output current

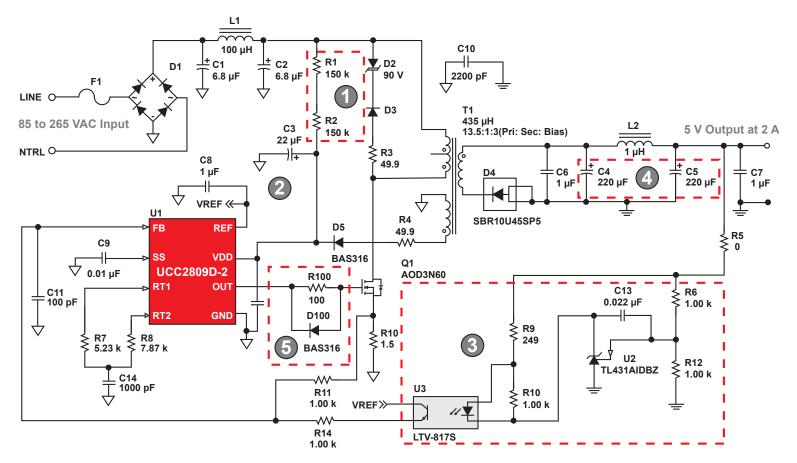
Control Methodologies Evaluated:

- DCM, fixed-frequency, control with opto feedback (DCM/FF/Opto)
- DCM with valley switching and PSR (DCM/VS/PSR)
- DCM with valley switching and opto feedback (DCM/VS/Opto)

Controlled Parameters:

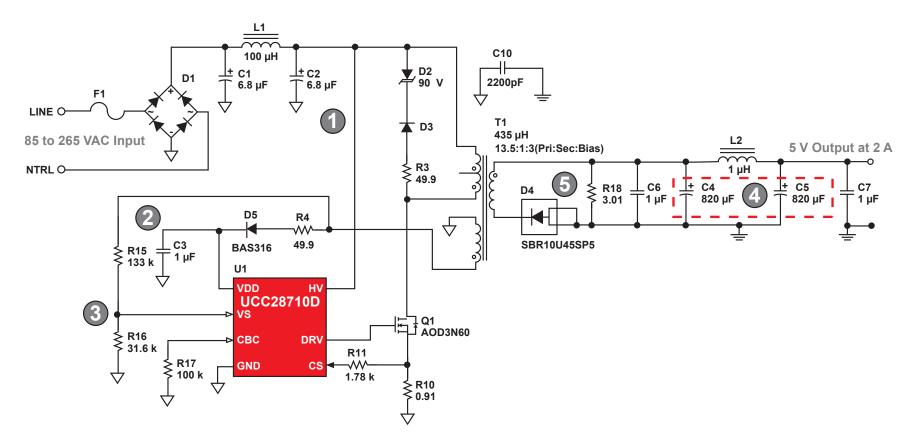
- All designs operate at ~100 kHz at maximum load
- Same transformer, FET, diode used on all designs

DCM/FF/Opto Example



- 1. Start-up resistors increase standby power
- 2. Large bias cap; factors include I_{DD} , opto current, UVLO hysteresis
- 3. TL431 and opto-coupler for regulation
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- 4. Faster loop response allows smaller output caps
- 5. Minimum on-time requires turn-on resistor at no load operation

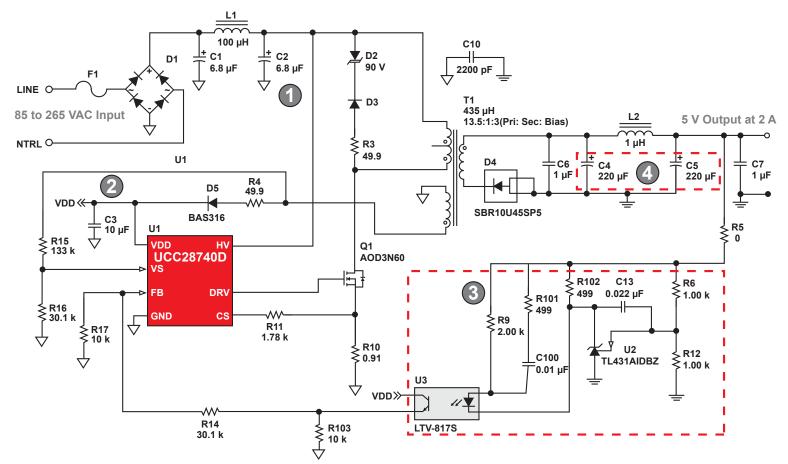
DCM/VS/PSR Example



- 1. No start-up resistors (lower standby)
- 2. Small bias capacitor
- 3. PSR eliminates opto-coupler and TL431

- 4. Larger output capacitors needed for transients
- 5. Small pre-load resistor needed for no load operation

DCM/VS/Opto Example



- 1. No start-up resistors (lower standby power)
- 2. Medium sized bias capacitor
- 3. TL431 and opto-coupler regulation

4. Faster loop response allows smaller output caps

Photographs

DCM/FF/Opto

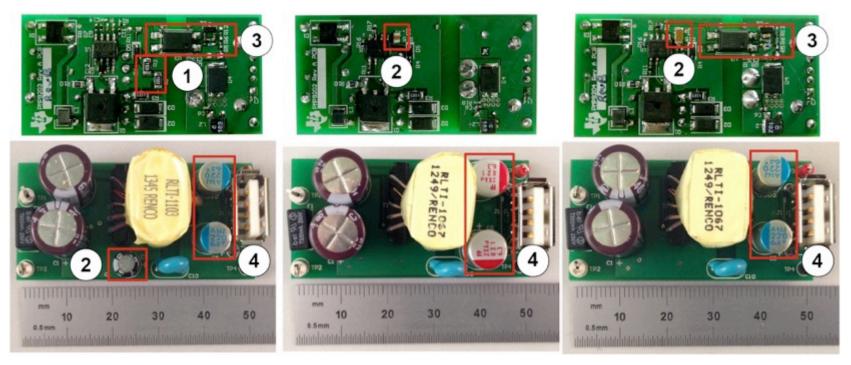
www.ti.com/tool/pmp9203

DCM/VS/PSR

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DCM/VS/Opto

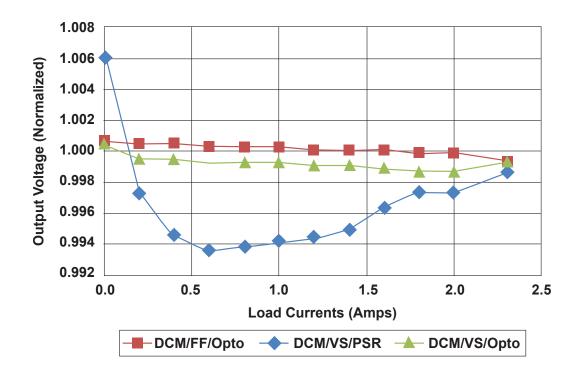
www.ti.com/tool/pmp9204



- 1. Start-up resistors
- 2. Bias capacitor

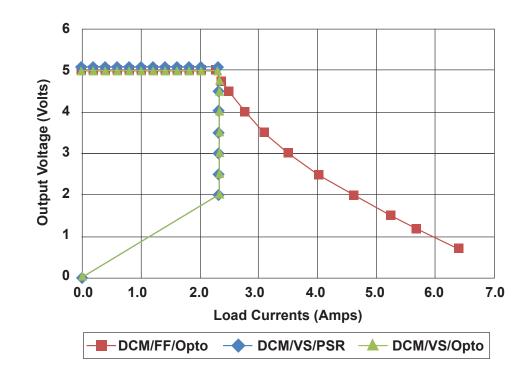
- 3. TL431 and opto-coupler
- 4. Bias capacitor

Load Regulation



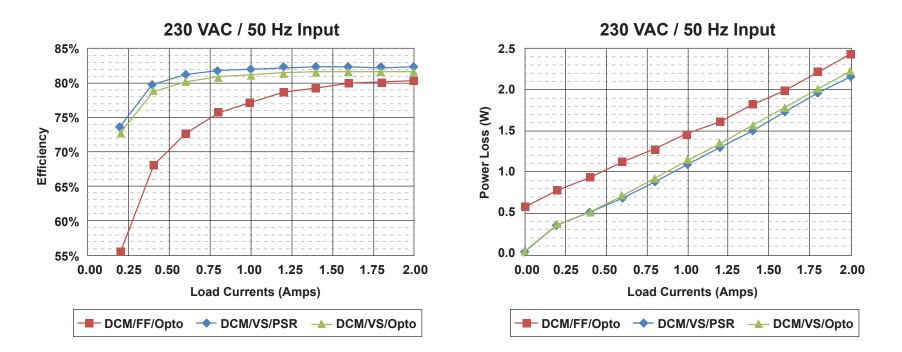
- TL431 and opto-coupler provides excellent load regulation
- PSR uses cable-drop compensation
 - Compensates for resistive drops on the secondary side
 - Keeps load regulation within +/-1%

Overload Protection



- Traditional fixed-frequency controller:
 - Frequency and peak current held constant
 - Currents during overload can become excessive
- DCM/VS controllers include current regulation feature

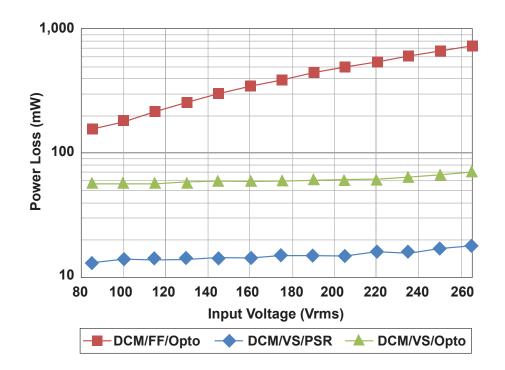
Efficiency



- All designs achieve >80% efficiency at max load
- DCM/VS controllers provide better efficiency at low to medium loads
 Due to reduced frequency operation
- Start-up resistors have major impact at higher input voltages

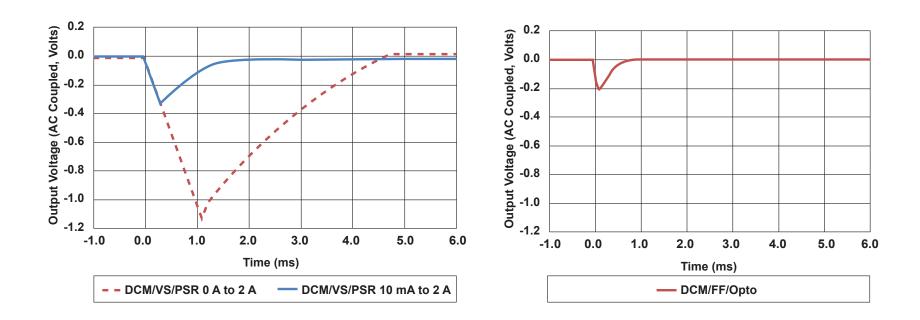
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Standby Power Consumption



- Pre-load resistor of PSR design accounts for a large portion of P_{sb}
- TL431 and opto-coupler biasing increases P_{sb}
- Fixed frequency example P_{sb} dominated by start-up resistors

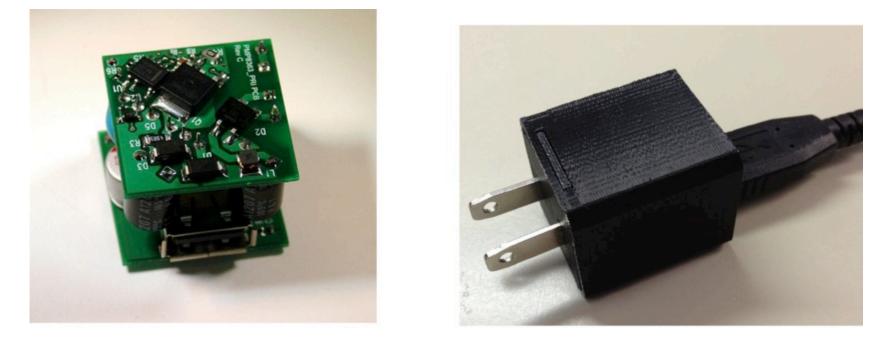
Load Transient Response



- PSR response varies
 - Dependent on when in the switching cycle the transient hits
 - Starting at 0 A vs. a few mA makes a big difference
- TL431 and opto-coupler response is predictable
 - Dependent on output capacitance and bandwidth

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Small Form Factor Example



- DCM/VS/PSR example design can be laid out to fit into a 1"x1" cube
- Two secondary transformer wires are the only electrical connection between the two circuit boards (not possible with opto feedback)
- Small product size requires efficiency >80% to prevent thermal issues
- PMP8363 available on PowerLab: http://www.ti.com/tool/pmp8363

Comparison Summary

	DCM/FF/Opto	DCM/VS/PSR	DCM/VS/Opto
Output Voltage Accuracy	+/-2%	+/-5%	+/-2%
Load Regulation	+/-0.1%	+/-0.6%	+/-0.1%
Max Load Eff. (115 VAC / 230 VAC)	82.0% / 80.4% ★	82.2% / 82.5% ★	81.3% / 81.7% ★
Standby Power (115 VAC / 230 VAC)	216 mW / 584 mW	14 mW / 16 mW ★	57 mW / 64 mW ★
Load Transients (0 A to 2 A)	-200 mV 🛛 ★	-1100 mV	-200 mV 🛛 ★
Current Regulation	Not Provided	+/-5%	+/-5%
# of Components	41	27 🔶	37
Relative Cost	Low	Lowest 🔶 🕇	Low

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